0.1-6.0GHz,2 stages, 8W, 28V GaN Fully matched PA Module

Description

The G2MAH0160-8 is a 10-watt ,2 stage integrated Power Amplifier Module, designed for broad band applications, with frequencies from 100MHz to 6.0GHz. The module is 50 Ω input/output matched and requires minimal external components.

The module implements distributed power amplifier in form of multi chips, housed in cost effective plastic open cavity package, offers a much lower cost than traditional MMIC solutions.

Vds=28V, Idq1=60mA, CW

Parameter	0.1GHz	1.0GHz	2.0GHz	3.0GHz	4.0GHz	5.0GHz	6.0GHz	6.2GHz	Units
Linear Gain	24.9	22.1	22.1	20.5	19.9	21.0	21.6	21.9	dB
Gain@Pin=22dBm	20.3	19.7	19.9	19.0	18.5	18.0	17.9	16.7	dB
Pout@Pin=22dBm	16.8	14.8	15.6	12.5	11.3	10.0	9.7	7.4	W
PAE@Pin=22dBm	59	47	48	35	33	30	38	36	%

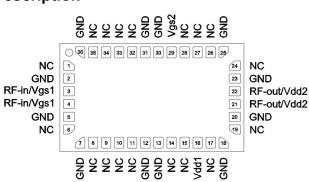
Product Features

- Operating Frequency Range: 0.1-6.0GHz
- Operating Drain Voltage: +28 V (Up to 32V)
- 50 Ω Input/Output
- Psat: ≥39dBm @28V, ≥40dBm @32V
- Small signal gain:>19dB, Power gain:>17dB @Pin=22dBm
- Minimum efficiency:>25%
- 6x10 mm Surface Mount Package
- Compliant to Restriction of Hazardous Substances (RoHS) Directive 2002/95/EC

Applications

- Ultra Broadband Amplifiers
- Fiber Drivers
- Test Instrumentation
- EMC Amplifier Drivers
- 2-way Radios

Pin Configuration and Description



Pin No.	Symbol	Description
21,22	RFout/Vdd2	Transistor 1, Drain Bias2 & RF Output
3,4	RFin/Vgs1	Transistor 1, Gate Bias1 & RF Input



Document Number: G2MAH0160-8 Preliminary Datasheet V1.0

29	Vgs2	Transistor 1, Gate Bias2		
16	Vdd1	Transistor 1, Drain Bias1		
Others	NC	No connection		
2,5,7,12, 13,18,20,23,25, 30, 31,36 Package Base	GND	DC/RF Ground. Must be soldered to EVB ground plane over array of vias for thermal and RF performance. Solder voids under Pkg Base will result in excessive junction temperatures causing permanent damage.		

Table 1. Maximum Ratings

Rating	Symbol	Value	Unit
DrainSource Voltage	V _{DSS}	150	Vdc
GateSource Voltage	V _{GS}	-10 to +2	Vdc
Operating Voltage	V _{DD}	+36	Vdc
Input CW Power	RFin	25	dBm
Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	Tc	+150	°C
Operating Junction Temperature	TJ	+225	°C

Table 2. Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case, FEA	Data	4.0	°C/W
T_c = 25°C, DC test	Rejc	4.9	C/W

Table 3. Electrical Characteristics

Parameter	Condition	Min	Тур	Max	Unit
Frequency Range		100		6000	MHz
Power Gain		17			dB
Pout	Pin=22dBm	39	40		dBm
Drain Efficiency @ P _{SAT}		25			%
Unless otherwise noted: TA = 25°C, V _{DD} =28 V, Pulse Width=100 us, Duty cycle=10%					

Load Mismatch of per Section (On Test Fixture, 50 ohm system): V_{DD} =28 V, I_{DQ} =60 mA, f = 3.5 GHz

VSWR 10:1 at pulse CW Output Power @Pin=22dBm	No Device Degradation
	No Device Degradation

Document Number: G2MAH0160-8 Preliminary Datasheet V1.0

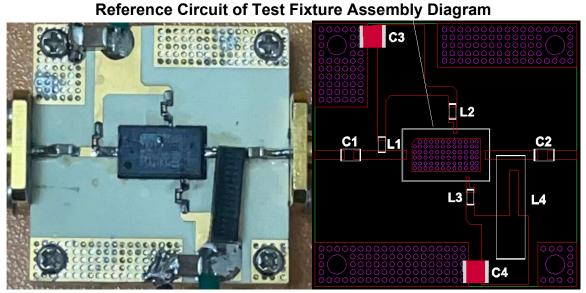
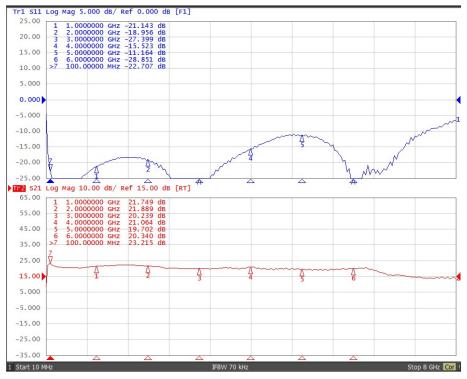


Figure 1. Test Circuit Component Layout

		Part NO.	Vendor
C1, C2	50V 1uF Chip Capacitor	GRM21BR71H105KA12L	muRata
C3,C4	10uF 100V Chip Capacitor	C5750X7S2A106M230KB	TDK
L1, L2,L3	470 nH Capacitor(0603)	LQW18CNR47J00D	muRata
L4	1.3uH 4.2A Inductor	4310LC-132KEC	Coilcraft
PCB	RO4350B,20mil,er=3.48		

TYPICAL CHARACTERISTICS

Figure 2. Network analyzer output S11/S21 (Pin=0dBm)



Document Number: G2MAH0160-8 Preliminary Datasheet V1.0

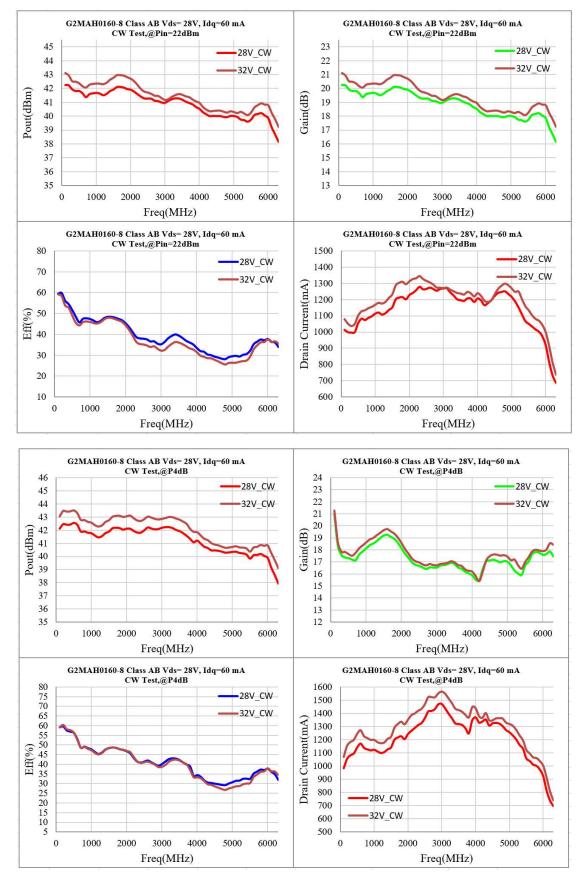
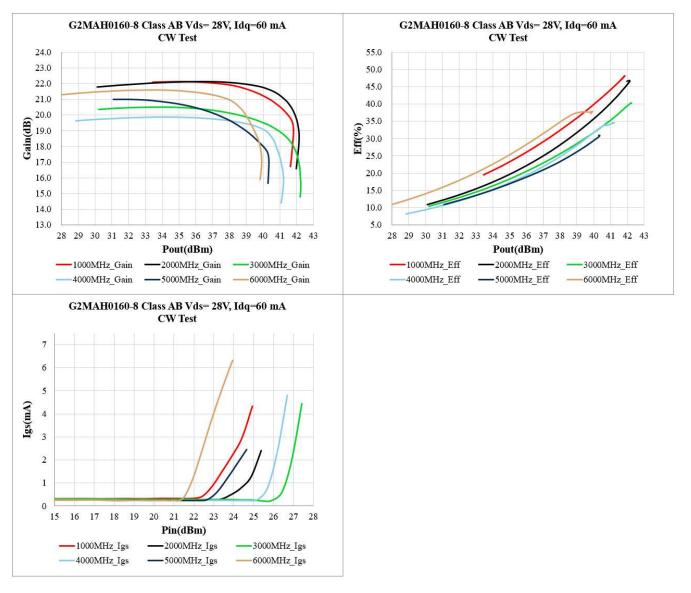


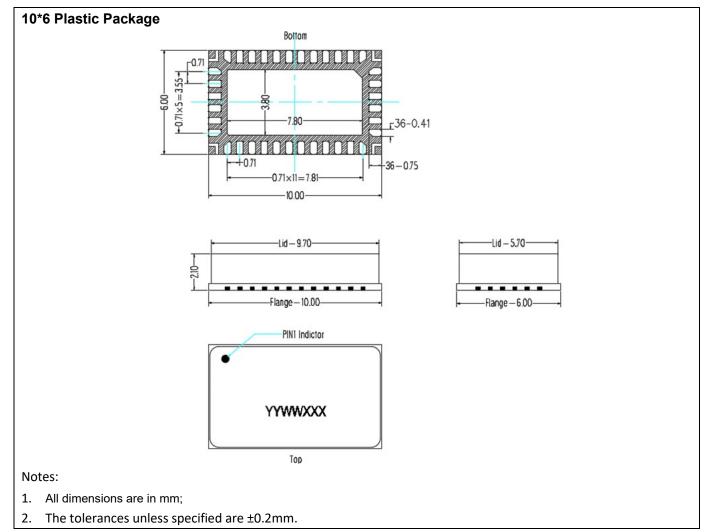
Figure 3. Power Gain and, efficiency and Pout @Pin=22dBm, P4dB vs. Frequency

Document Number: G2MAH0160-8 Preliminary Datasheet V1.0

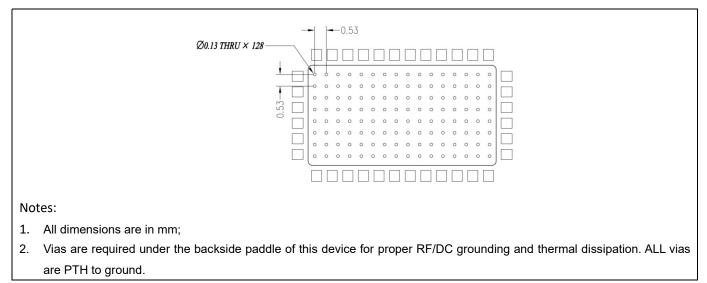
Figure 4. AM/AM Plot



Package Dimensions



Mounting Footprint Pattern



Revision history

Table 6. Document revision history

Date	Revision	Datasheet Status
2023/5/11	Rev 1.0	Preliminary Datasheet Creation

Application data based on ZHH-23-07

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